

/ MOS FIELD EFFECT TRANSISTOR 2SK2355, 2SK2355-Z/2SK2356, 2SK2356-Z

SWITCHING N-CHANNEL POWER MOS FET INDUSTRIAL USE

DESCRIPTION

The 2SK2355, 2SK2355-Z/2SK2356, 2SK2356-Z is N-Channel MOS Field Effect Transistor designed for high voltage switching applications.

FEATURES

Low On-Resistance

2SK2355: RDS(on) = 1.4 Ω (VGS = 10 V, ID = 2.5 A)

2SK2356: RDS(on) = 1.5 Ω (VGS = 10 V, ID = 2.5 A)

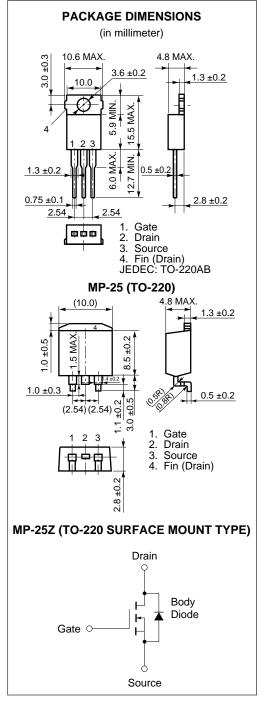
• Low Ciss Ciss = 670 pF TYP.

· High Avalanche Capability Ratings

ABSOLUTE MAXIMUM RATINGS $(T_A = 25 \degree C)$

Drain to Source Voltage (2SK2355/2356)	VDSS	450/500	V
Gate to Source Voltage	Vgss	±30	V
Drain Current (DC)	ID(DC)	±5.0	Α
Drain Current (pulse)*	D(pulse	±20	Α
Total Power Dissipation (Tc = 25 °C)	P _{T1}	50	W
Total Power Dissipation (Ta = 25 °C)	P _{T2}	1.5	W
Channel Temperature	T_ch	150	$^{\circ}\text{C}$
Storage Temperature	Tstg	-55 to +150	°C
Single Avalanche Current**	las	5.0	Α
Single Avalanche Energy**	Eas	17.4	mJ

- * PW \leq 10 μ s, Duty Cycle \leq 1 %
- ** Starting T_{ch} = 25 °C, R_G = 25 Ω , V_{GS} = 20 V \rightarrow 0



The information in this document is subject to change without notice.

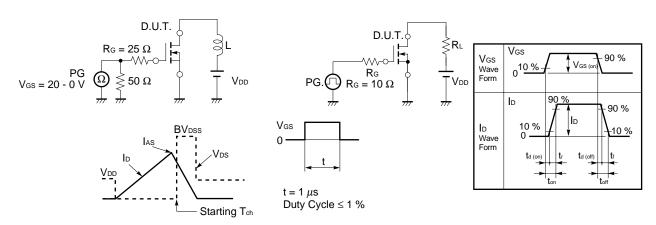


ELECTRICAL CHARACTERISTICS (TA = 25 °C)

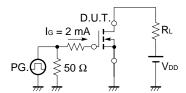
CHARACTERISTIC	SYMBOL	MIN.	TYP.	MAX.	UNIT	TEST CONDITIONS	
Drain to Source On-Resistance	RDS(on)		0.9	1.4	mΩ	Vgs = 10 V	2SK2355
			1.0	1.5		ID = 2.5 A	2SK2356
Gate to Source Cutoff Voltage	V _{GS(off)}	2.5		3.5	V	V _{DS} = 10 V, I _D = 1 mA	
Forward Transfer Admittance	yfs	1.0			S	V _{DS} = 10 V, I _D = 2.5 A	
Drain Leakage Current	IDSS			100	μΑ	VDS = VDSS, VGS = 0	
Gate to Source Leakage Current	Igss			±100	nA	$V_{GS} = \pm 30 \text{ V}, V_{DS} = 0$	
Input Capacitance	Ciss		670		pF	V _{DS} = 10 V	
Output Capacitance	Coss		140		pF	Vgs = 0	
Reverse Transfer Capacitance	Crss		18		pF	f = 1 MHz	
Turn-On Delay Time	td(on)		11		ns	ID = 2.5 A	
Rise Time	tr		8		ns	Vgs = 10 V	
Turn-Off Delay Time	t _{d(off)}		40		ns	VDD = 150 V	
Fall Time	tf		8		ns	R_G = 10 Ω R_L = 60 Ω	
Total Gate Charge	Q _G		20		nC	ID = 5.0 A	
Gate to Source Charge	QGS		4.5		nC	V _{DD} = 400 V	
Gate to Drain Charge	Q _{GD}		9		nC	Vgs = 10 V	
Body Diode Forward Voltage	V _F (S-D)		1.0		V	IF = 5.0 A, Vo	ss = 0
Reverse Recovery Time	trr		270		ns	IF = 5.0 A, Vo	ss = 0
Reverse Recovery Charge	Qrr		1.0		nC	di/dt = 50 A/µ	ıs

Test Circuit 1 Avalanche Capability

Test Circuit 2 Switching Time

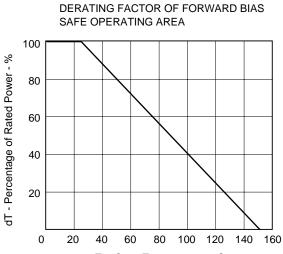


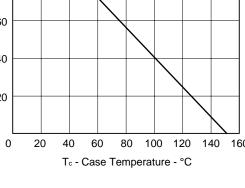
Test Circuit 3 Gate Charge

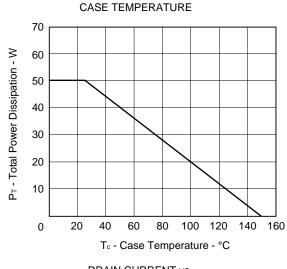


The application circuits and their parameters are for references only and are not intended for use in actual design-in's.

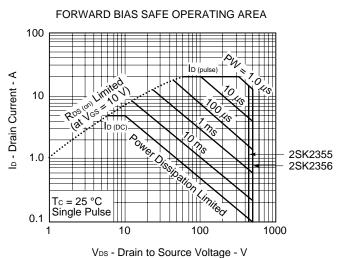
TYPICAL CHARACTERISTICS (TA = 25 °C)



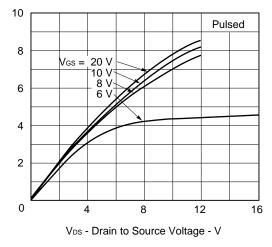




TOTAL POWER DISSIPATION vs.

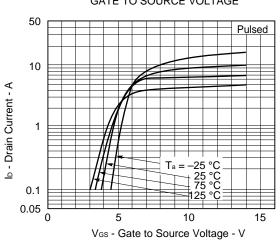


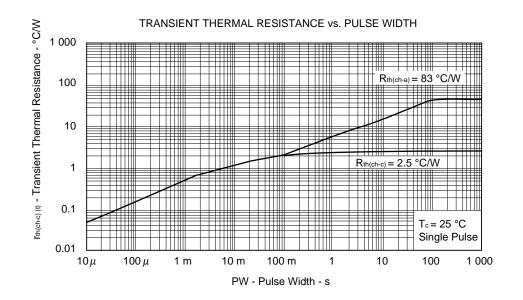




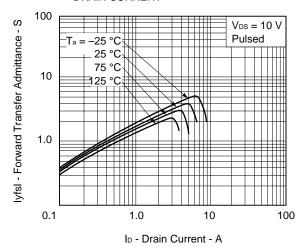
lo - Drain Current - A



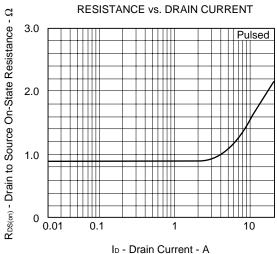




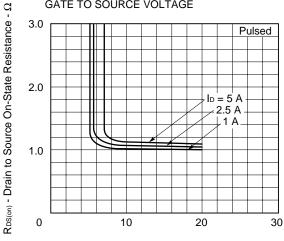
FORWARD TRANSFER ADMITTANCE vs. DRAIN CURRENT



DRAIN TO SOURCE ON-STATE

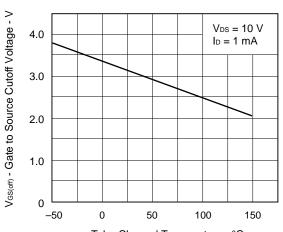


DRAIN TO SOURCE ON-STATE RESISTANCE vs. GATE TO SOURCE VOLTAGE

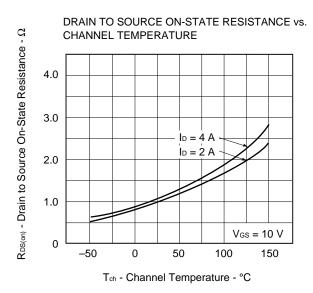


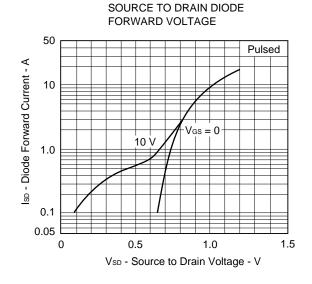
V_{GS} - Gate to Source Voltage - V

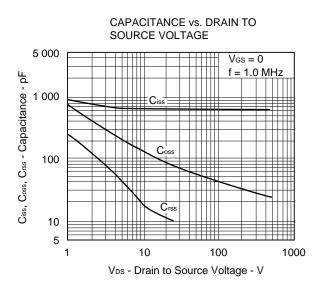
GATE TO SOURCE CUTOFF VOLTAGE vs. CHANNEL TEMPERATURE

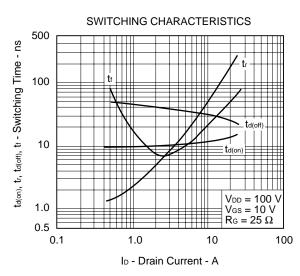


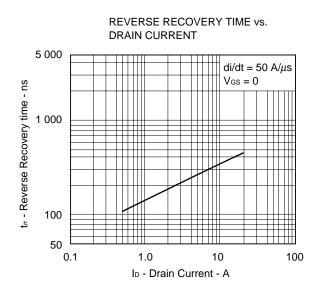
Tch - Channel Temperature - °C

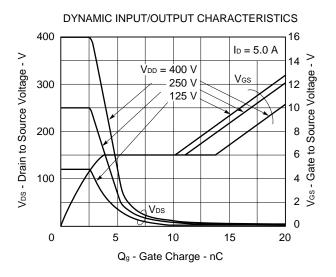




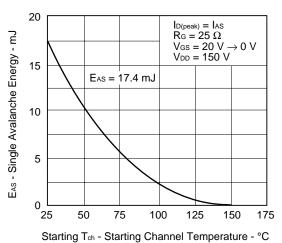




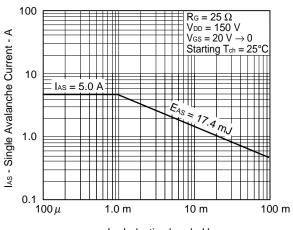




SINGLE AVALANCHE ENERGY vs STARTING CHANNEL TEMPERATURE



SINGLE AVALANCHE CURRENT vs INDUCTIVE LOAD



REFERENCE

Document Name	Document No.
NEC semiconductor device reliability/quality control system.	C11745E
Quality grades on NEC semiconductor devices.	C11531E
Semiconductor device mounting technology manual.	C10535E
Semiconductor device package manual.	C10943X
Guide to quality assurance for semiconductor devices.	MEI-1202
Semiconductor selection guide.	X10679E
Power MOS FET features and application switching to power supply.	D12971E
Application circuits using Power MOS FET.	D12972E
Safe operating area of Power MOS FET.	D13085E

The diode connected between the gate and source of the transistor serves as a protector against ESD. When this device is actually used, an additional protection circuit is externally required if a voltage exceeding the rated voltage may be applied to this device.

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Anti-radioactive design is not implemented in this product.